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The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

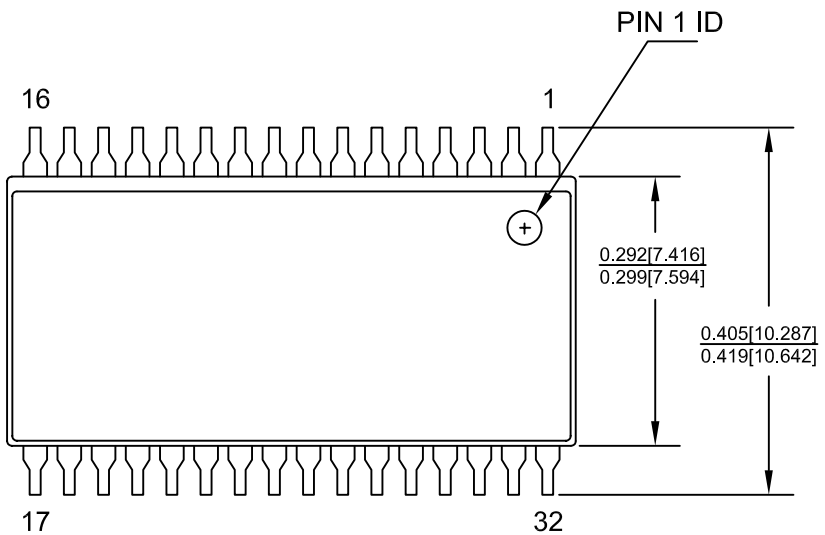
Continuity of document content

The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

32 Lead (300 Mil) SOIC

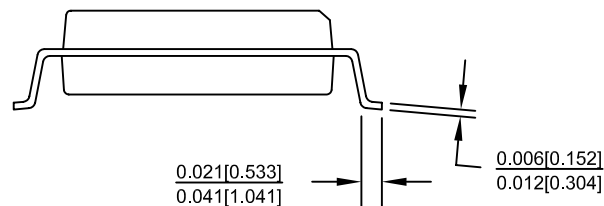
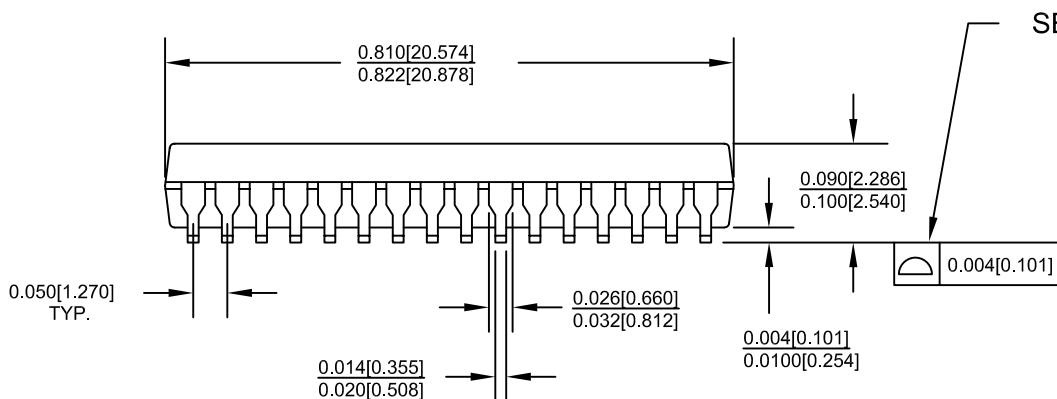



DIMENSIONS IN INCHES[MM]

MIN.
MAX.

REFERENCE JEDEC MO-119

PART #	
S32.3	STANDARD PKG.
SZ32.3	LEAD FREE PKG.




 CYPRESS Company Confidential	
TITLE PACKAGE OUTLINE, 32LD SOIC 300 MIL S32.3/SZ32.3	
SPEC NO. 51-85127	REV *D
SCALED TO FIT N/A	SHEET 1 OF 2

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PACKAGE CODE(S)
S323
SZ323

REV.	ECN NO.	ORIGIN OF CHANGE	DESCRIPTION OF CHANGE
**	101701	—	NEW RELEASE
*A	128917	—	ADD MM DIM./ ADD JEDEC #/ ADD SZ PART #.
*B	2813799	—	Changed Template & Title from 32LD (300 MIL) SOIC PKG OUTLINE to PACKAGE OUTLINE, 32LD SOIC 300 MIL S32.3/SZ32.3.
*C	3313142	—	NO CHANGE. SUNSET REVIEW.
*D	4615792	XANC	FOR SUNSET REVIEW. UPDATE DRAWING TEMPLATE.

 CYPRESS Company Confidential	
TITLE PACKAGE OUTLINE, 32LD SOIC 300 MIL S32.3/SZ32.3	
SPEC NO. 51-85127	REV *D
SCALED TO FIT N/A	SHEET 2 OF 2

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